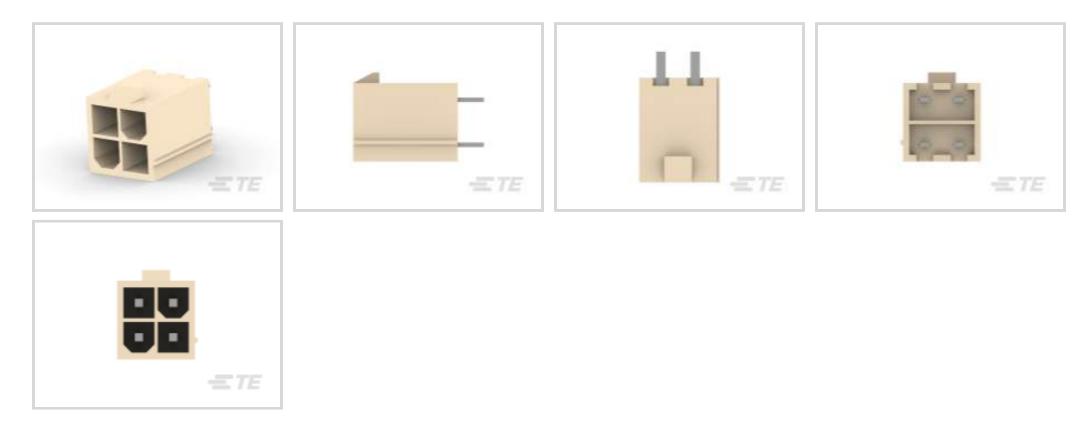


ATX Power

TE Internal #: 4-1775099-0 PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 1.4 mm [. 055 in] Centerline, Tin, Through Hole - Solder, Power, Ivory, ATX Power

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: Wire-to-Board

Number of Positions: 4

Number of Rows: 2

Centerline (Pitch): 1.4 mm [.055 in]

PCB Mount Orientation: Vertical

Features

E T E connectivity

Product Type Features

Connector System	Wire-to-Board			
Sealable	No			
Connector & Contact Terminates To	Printed Circuit Board			
PCB Connector Assembly Type	PCB Mount Header			
Configuration Features				
Number of Positions	4			
Number of Rows	2			
PCB Mount Orientation	Vertical			
Electrical Characteristics				
Operating Voltage	250 VAC			
Body Features				
Primary Product Color	lvory			
Contact Features				

C For support call+1 800 522 6752

PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 1.4 mm [.055 in] Centerline, Tin, Through Hole - Solder, Power, Ivory, ATX Power



PCB Contact Termination Area Plating Material Thickness	3.05 μm[120.07 μin]		
Contact Layout	Matrix		
Mating Tab Width	1.14 mm[.044 in]		
Mating Tab Thickness	1.1 mm[.043 in]		
Contact Underplating Material Thickness	1.27 μm[50 μin]		
Contact Mating Area Plating Material Thickness	3.05 μm[120.07 μin]		
PCB Contact Termination Area Plating Material Finish	Matte		
Contact Mating Area Plating Material Finish	Matte		
Contact Underplating Material	Nickel		
PCB Contact Termination Area Plating Material	Tin		
Contact Mating Area Plating Material	Tin		
Contact Type	Pin		
Contact Current Rating (Max)	9 A		
Termination Features			

Rectangular Termination Post & Tail Thickness	.55 mm[.021 in]
Rectangular Termination Post & Tail Width	1.14 mm[.044 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

Mechanical Attachment

	08/07/2023 03-5
Operation/Application	
Operating Temperature Range	-25 – 85 °C[-13 – 185 °F]
Usage Conditions	
Row-to-Row Spacing	4.2 mm[.165 in]
Dimensions	
Centerline (Pitch)	1.4 mm[.055 in]
Housing Material	PA 9T
Housing Features	
PCB Mount Retention	With
PCB Mount Alignment	Without
Mating Alignment	With
Connector Mounting Type	Board Mount
Mating Retention	Without
Mating Alignment Type	Polarization

L For support call+1 800 522 6752

08/07/2023 03:54AM | Page 2

PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 1.4 mm [.055 in] Centerline, Tin, Through Hole - Solder, Power, Ivory, ATX Power



Circuit Application	Power
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Type	Tray
Product Compliance For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2022 (223) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

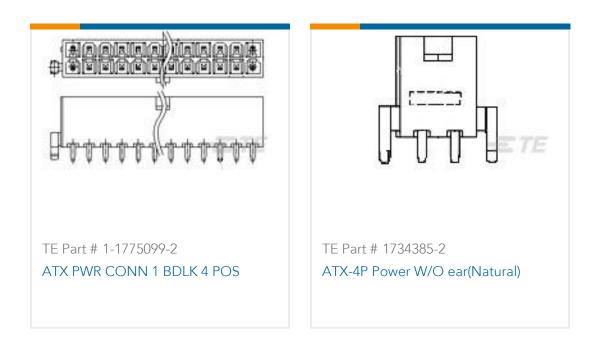
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 1.4 mm [.055 in] Centerline, Tin, Through Hole - Solder, Power, Ivory, ATX Power





Also in the Series | ATX Power



Customers Also Bought



TE Part #5747840-4 HD-20 PLUG RA .318 FMS BD-LK 4	TE Part #3-641238-2 02P MTA100 CONN ASSY NATL 30AU	TE Part #1825097-6 TPB11CGRA004	TE Part #1-1775099-3 ATX PWR CONN 1 BDLK 24 POS
	ETE		
TE Part #5-104809-4 05 MTE HDR SRST LATCH W/HLDWN	TE Part #2327672-1 RECEPT ASSY, RA, 56 POS, SLIVER 2.0	TE Part #1473969-1 REC ASS'Y FOR 2.5 SLIM BATTERY	

Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_4-1775099-0_E.2d_dxf.zip

English

PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 1.4 mm [.055 in] Centerline, Tin, Through Hole - Solder, Power, Ivory, ATX Power



Customer View Model

ENG_CVM_CVM_4-1775099-0_E.3d_igs.zip

English

Customer View Model ENG_CVM_CVM_4-1775099-0_E.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Product Specification

English